



20V PNP HIGH GAIN TRANSISTOR IN SOT89

Features

- BV_{CEO} > -20V
- I_C = -5A Continuous Current
- Low Saturation Voltage V_{CE(sat)} < -0.5V @ -50mA
- P_D = 2.4W Power Dissipation
- R_{sat} = 39mΩ for a Low Equivalent On-Resistance
- Complementary part number ZXTN25020DZ
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: SOT89
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 ³
- Weight: 0.05 grams (Approximate)

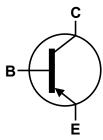
Application

- DC-DC converters
- Load switch
- Motor drive
- Disconnect switch
- MOSFET and IGBT gate drive

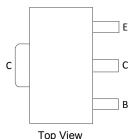
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SOT89

Top View



Device Symbol



Pin Out

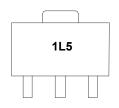
Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel
ZXTP25020DZTA	Standard	1L5	7	12	1,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



1L5 = Product Type Marking Code



Absolute Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-25	V
Collector-Emitter Voltage	V _{CEO}	-20	V
Emitter-Collector voltage (reverse blocking)	V _{ECO}	-4	V
Emitter-Base Voltage	V_{EBO}	-7	V
Continuous Collector Current	Ic	-5	A
Base current	lΒ	-1	A
Peak Pulse Current (Single pulse)	Ісм	-10	А

Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

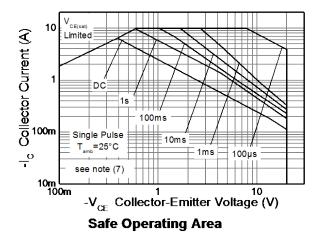
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5) Linear Derating Factor	P _D	1.1 8.8	W mW/°C
Power Dissipation (Note 6) Linear Derating Factor	P _D	1.8 14.4	W mW/°C
Power Dissipation (Note 7) Linear Derating Factor	P _D	2.4 19.2	W mW/°C
Power Dissipation (Note 8) Linear Derating Factor	P _D	4.46 35.7	W mW/°C
Power Dissipation (Note 9) Linear Derating Factor	P _D	15.7 126	W mW/°C
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ heta JA}$	117	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	$R_{ heta JA}$	68	°C/W
Thermal Resistance, Junction to Ambient (Note 7)	R _{θJA}	51	°C/W
Thermal Resistance, Junction to Ambient (Note 8)	R _{0JA}	28	°C/W
Thermal Resistance, Junction to Case (Note 9)	R _{θJC}	7.95	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

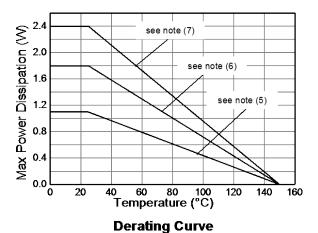
Notes:

- 5. For a device surface mounted on 15mm x 15mm x 0.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; device measured when operating in steady state condition.
- 6. Same as note (5), except the device is mounted on 25mm x 25mm x 0.6mm single sided 1oz weight copper.
- 7. Same as note (5), except the device is mounted on 50mm x 50mm x 0.6mm single sided 1oz weight copper.
- 8. Same as note (5), except the device is measured at t<5 seconds 9. Junction to case (collector tab). Typical.



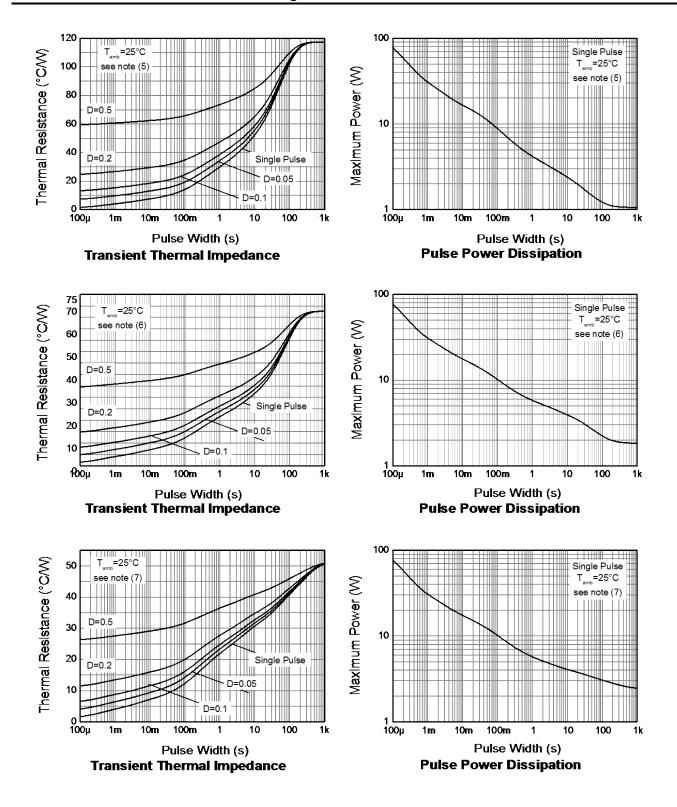
Thermal Characteristics and Derating Information







Thermal Characteristics and Derating Information





Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

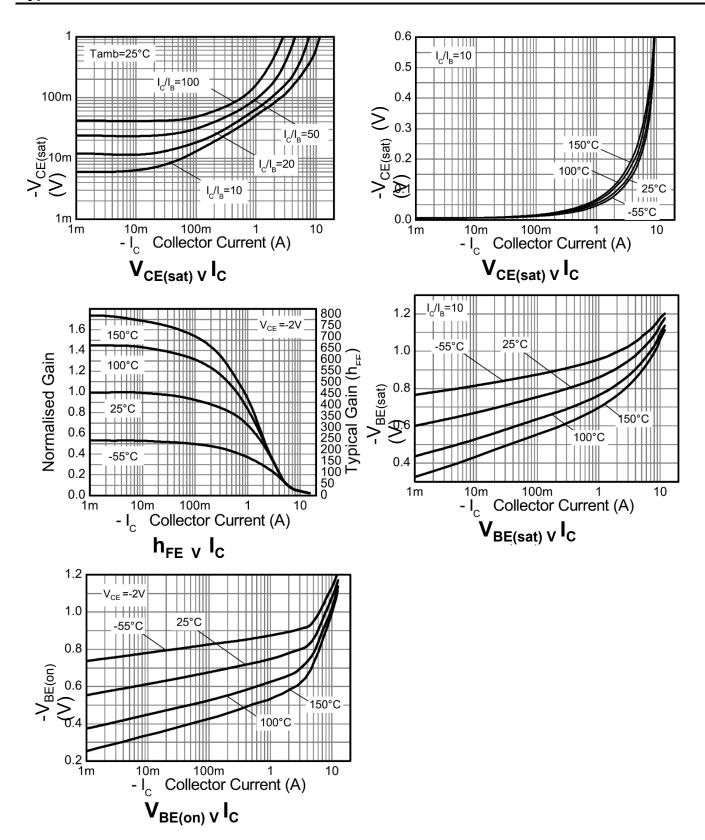
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-25	-55	_	V	$I_C = -100 \mu A$
Collector- Emitter Breakdown Voltage (Note 10)	BV _{CEO}	-20	-45	_	V	I _C = -10mA
Emitter-collector breakdown voltage (reverse blocking)	BV_{ECX}	-4	-8.5	_	V	I_E = -100μA, $R_{BC} \le 1k\Omega$ or 0.25V > V_{BE} > -0.25V
Emitter-Collector Breakdown Voltage	BV _{ECO}	-4	-8.5	_	V	I _E = -100μA
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	-8.3	_	V	I _E = -100μA
Collector Cut-Off Current	I _{CBO}	_	-1 —	-50 -0.5	nA μA	V _{CB} = -25V V _{CB} = -25V, T _A = +100°C
Emitter Cut-Off Current	I _{EBO}	_	-1	-50	nA	V _{EB} = -5.6V
Collector-Emitter Saturation Voltage (Note 10)	V _{CE(sat)}	_	-50 -150 -185 -195	-65 -215 -245 -265	mV	$I_C = -1A$, $I_B = -100mA$ $I_C = -1A$, $I_B = -10mA$ $I_C = -2A$, $I_B = -40mA$ $I_C = -5A$, $I_B = -500mA$
Base-Emitter Saturation Voltage (Note 10)	V _{BE(sat)}	_	-1010	-1100	mV	I _C = -5A, I _B = -500mA
Base-Emitter Turn-On Voltage (Note 10)	V _{BE(on)}	_	-870	-1000	mV	I _C = -5A, V _{CE} = -2V
DC current gain (Note 10)	h _{FE}	300 200 45 —	450 310 85 20	900 — — —	_	I_{C} = -10mA, V_{CE} = -2V I_{C} = -1A, V_{CE} = -2V I_{C} = -5A, V_{CE} = -2V I_{C} = -10A, V_{CE} = -2V
Transitional frequency	f _T	_	290	_	MHz	I _C = -50mA, V _{CE} = -10V, f = 100MHz
Input Capacitance	Ci _{bo}	_	21	_	pF	V _{EB} = -0.5V, f = 1MHz
Output Capacitance	C _{obo}	_	157	_	pF	V _{CB} = -10V, f = 1MHz
Delay time	t _d		14.2			
Rise time	t _r		16.3		no	$I_C = -1A$, $V_{CC} = -10V$,
Storage time	rage time t _s		186		ns	$I_{B1} = -I_{B2} = -50 \text{mA}$
Fall time	t _f		32.7			

Note:

10. Measured under pulsed conditions. Pulse width ≤ 300µs. Duty cycle ≤ 2%.



Typical Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

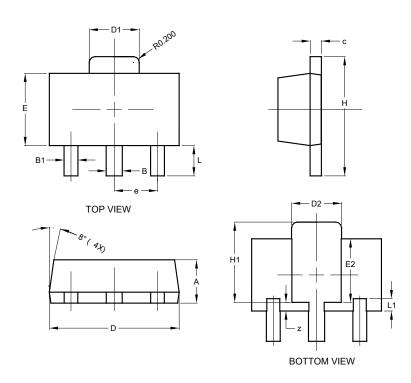




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT89

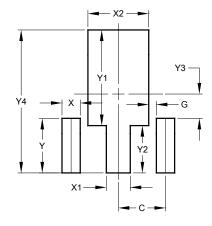


SOT89					
Dim	Min	Max	Тур		
Α	1.40	1.60	1.50		
В	0.50	0.62	0.56		
B1	0.42	0.54	0.48		
С	0.35	0.43	0.38		
D	4.40	4.60	4.50		
D1	1.62	1.83	1.733		
D2	1.61	1.81	1.71		
Е	2.40	2.60	2.50		
E2	2.05	2.35	2.20		
е	-	ı	1.50		
Н	3.95	4.25	4.10		
H1	2.63	2.93	2.78		
L	0.90	1.20	1.05		
L1	0.327	0.527	0.427		
Z	0.20	0.40	0.30		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT89



Dimensions	Value		
	(in mm)		
С	1.500		
G	0.244		
Х	0.580		
X1	0.760		
X2	1.933		
Υ	1.730		
Y1	3.030		
Y2	1.500		
Y3	0.770		
Y4	4 530		



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